

FIG. 1

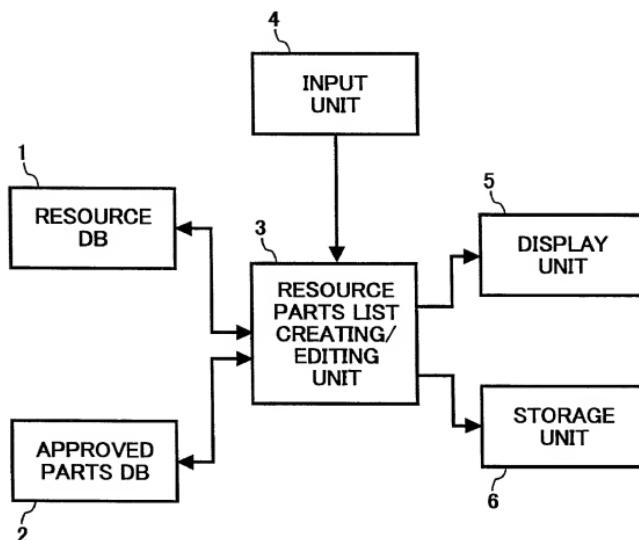


FIG. 2

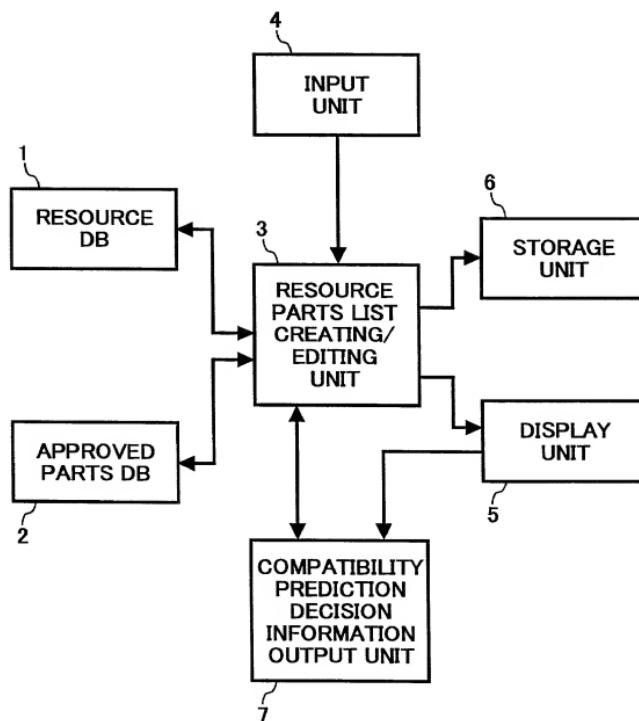


FIG. 3A

	FUNCTION LEVEL 1	FUNCTION LEVEL 2	FUNCTION LEVEL 3	
1	READ	IMAGE SENSOR		SENSING
2	READ	ANALOGUE SIGNAL PROCESSING	DIRTY BACKGROUND REMOVAL	ELECTRICAL

FIG. 3B

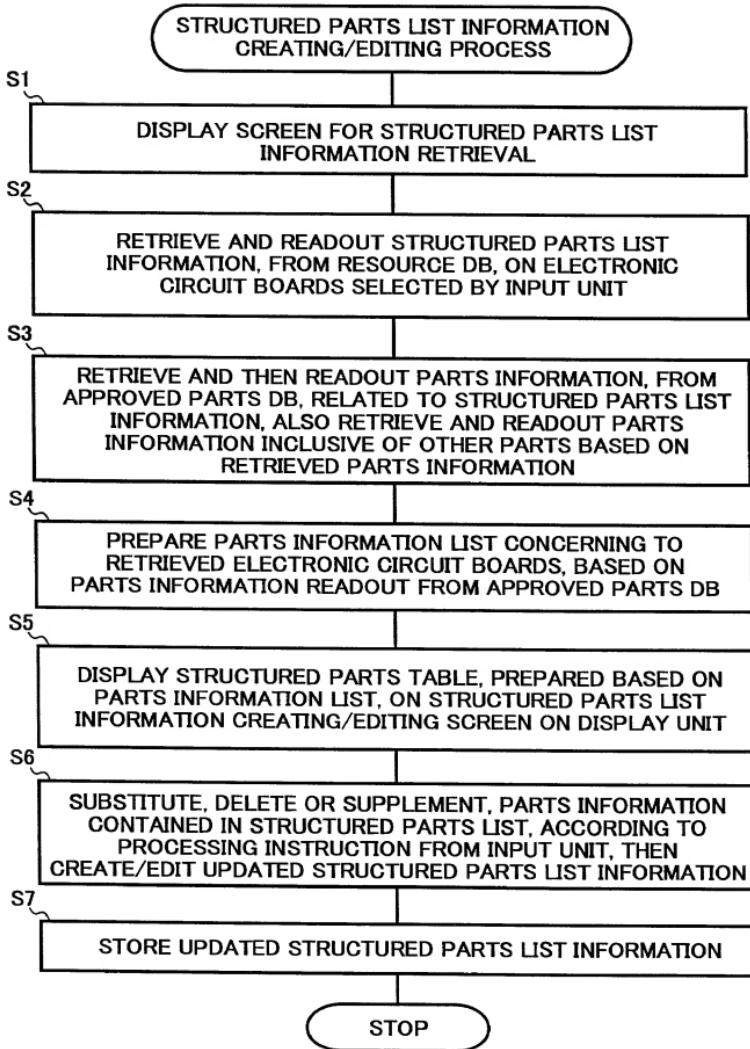
QUANTITY

	FUNCTIONAL DEVICE	MAKER	MAKER'S MODEL NUMBER	MAKER'S PART NUMBER	UNIT PRICE	
1	CCD LINEAR IMAGE SENSOR	A CO.	XXXXXX	XXXXXX	XXXX	1
2	CUSTOM IC	B CO.	XXXXXX	XXXXXX	XXXX	1

FIG. 3C

	PCB	USER'S PART NUMBER	UNIT
1	PRINTED BOARD: XX TYPE	XXXXXX	SCANNER
2	PRINTED BOARD: XX TYPE	XXXXXX	SCANNER

## FIG. 4



5  
FIG.

FIG. 6

PART CLASS		CHARACTERISTICS			PRICE WHEN MASS-PRODUCED		
PCB NAME	PCB	NAME	VALUE	UNIT	NET COST	ESTIMATED PRICE	WHEN MASS-PRODUCED
PROD LOCATION	...	...	...	...	...	...	...
PCB PART NUMBER	...	...	...	...	...	...	...
PART NAME	...	...	...	...	...	...	...
MODEL STATUS	...	...	...	...	...	...	...
TARGET PRICE (DESIRED)	...	NET PRICE	...	...	NET COST	...	...
TARGET PRICE (MANDATORY)	...	...	...	...	...	...	...
STATUS	PART NUMBER	PART CLASS	MAKER'S MODEL NO.	MAKER	ALTERATION	QUANTITY	CURRENT PRICE
RECOMMENDED	01234	CONNECTOR TO/FROM BOARD	151525-3	A ELECTRONICS	...	...	...
APPROVED	50011	SIGNAL SYSTEM	153123-7	A ELECTRONICS	...	...	...
APPROVED	51907	CONNECTOR SIGNAL SYSTEM	153123-8	A ELECTRONICS	...	...	...
APPROVED	08812	TRANSISTOR	AB114	B ELECTRIC	...	...	...
APPROVED	08643	TRANSISTOR	AB333	B ELECTRIC	...	...	...
APPROVED	04438	RESISTOR ARRAY	3-GEG-1	C INDUSTRY	...	...	...
...	...	...	...	...	...	...	...

FIG. 7

PART CLASS	PCB			CHARACTERISTICS			PRICE WHEN MASS-PRODUCED
	...	...	...	NAME	VALUE	UNIT	
PCB NAME	...	...	...				...
PROD LOCATION	...	...	...				...
PCB PART NUMBER	...	...	...				...
PART NAME	...	...	...				...
MODEL STATUS	...	...	...				...
TARGET PRICE (DESIRED)	...	...	NET PRICE	...	NET COST		
TARGET PRICE (MANDATORY)	...	...	CURRENT PRICE	...	ESTIMATED PRICE		
						WHEN MASS-PRODUCED	
STATUS	PART NUMBER	PART CLASS	MAKER'S MODEL NO.	MAKER	ALTERATION	QUANTITY	CURRENT PRICE
RECOMMENDED	01234	CONNECTOR TO/FROM BOARD	151525-3	A ELECTRONICS	...	...	...
APPROVED	50011	SIGNAL SYSTEM	153123-7	A ELECTRONICS	...	...	...
APPROVED	51907	CONNECTOR SIGNAL SYSTEM	153123-8	A ELECTRONICS	...	...	...
RECOMMENDED	70458	TRANSISTOR	M11LL33	M FACTORY	...	...	...
APPROVED	08643	TRANSISTOR	AB333	B ELECTRIC	...	...	...
APPROVED	04438	RESISTOR ARRAY	3-GEG-1	C INDUSTRY	...	...	...
RECOMMENDED	202201	MEMORY DRAM	M72-125	N PART INDUSTRY	...	...	...
...	...	...	...	...	...	...	...

## FIG. 8

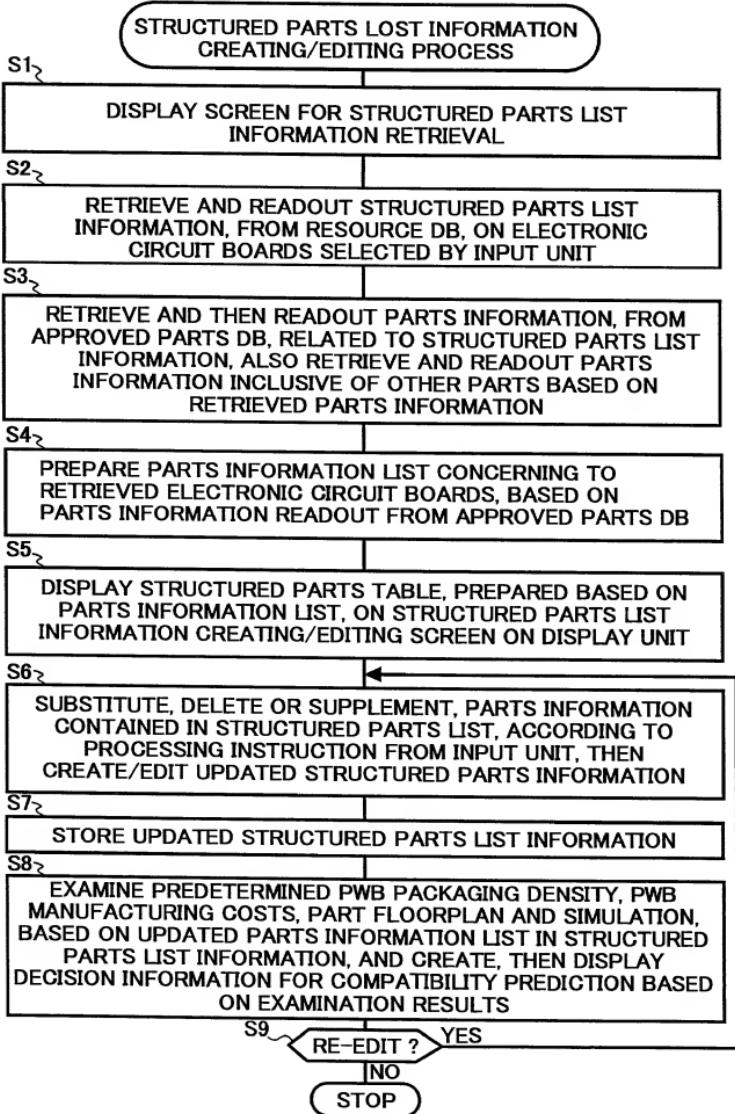


FIG. 9A

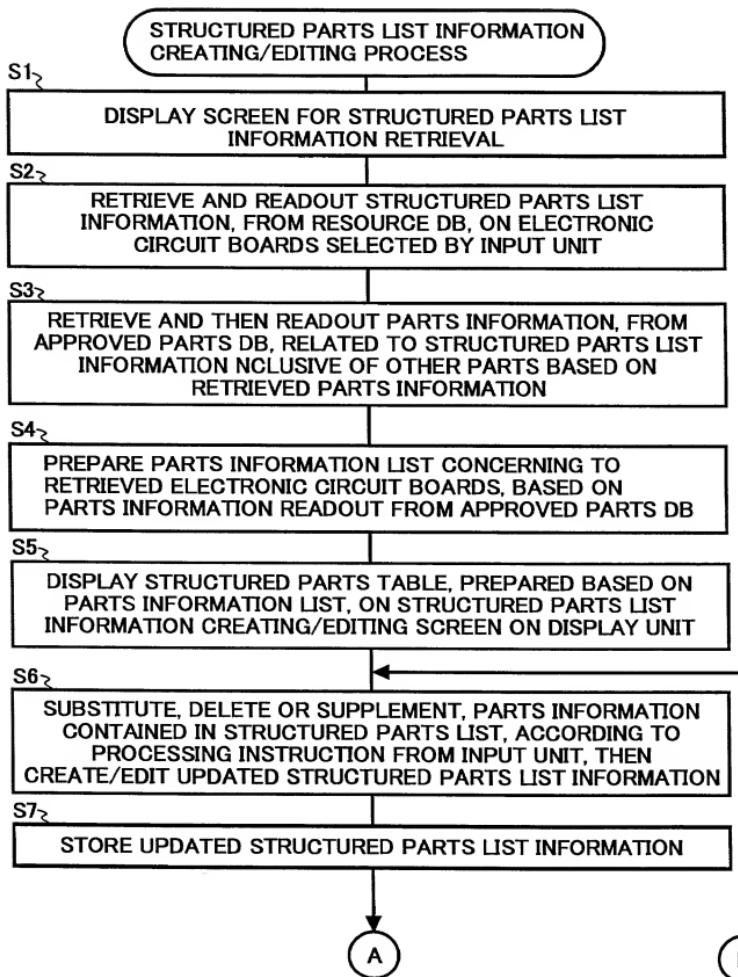


FIG. 9B

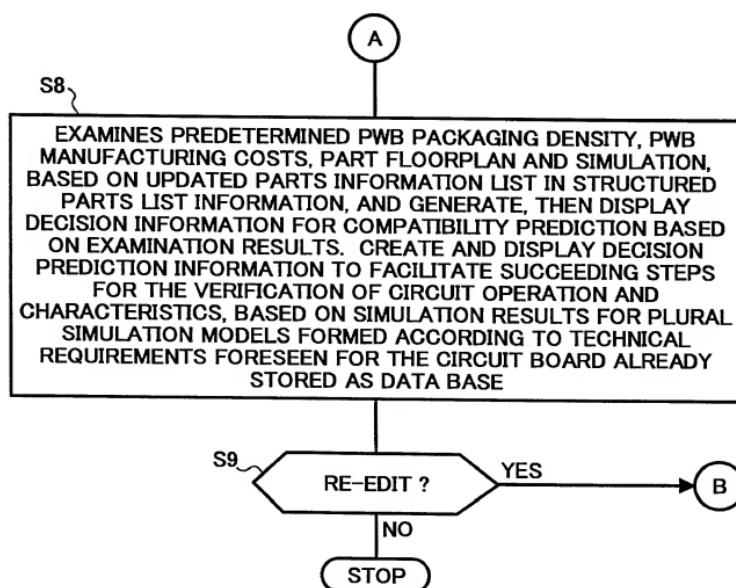


FIG. 10

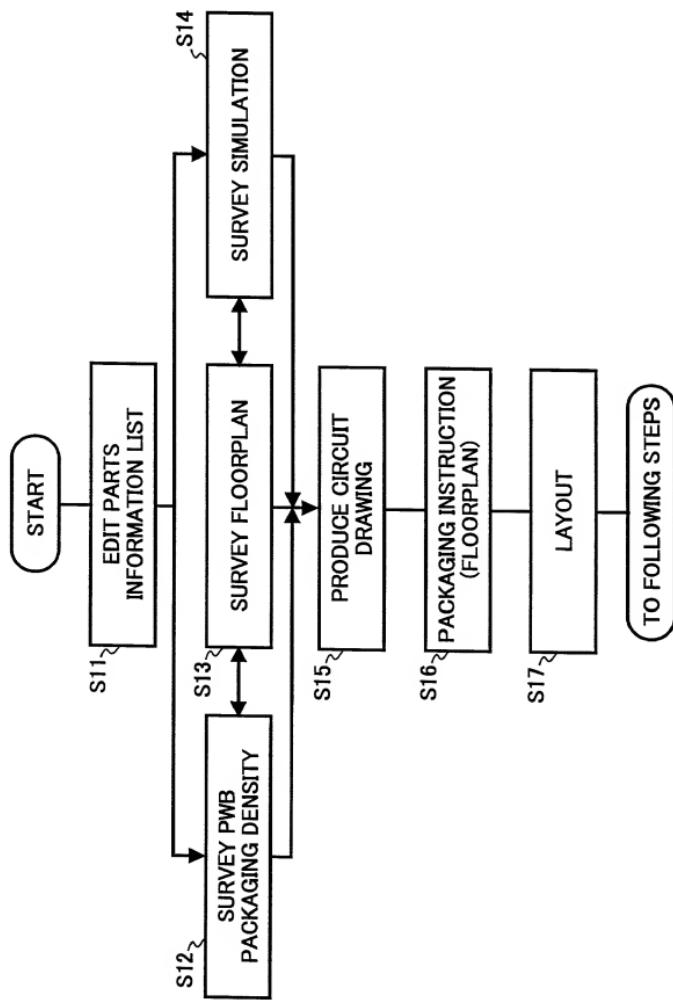


FIG. 11

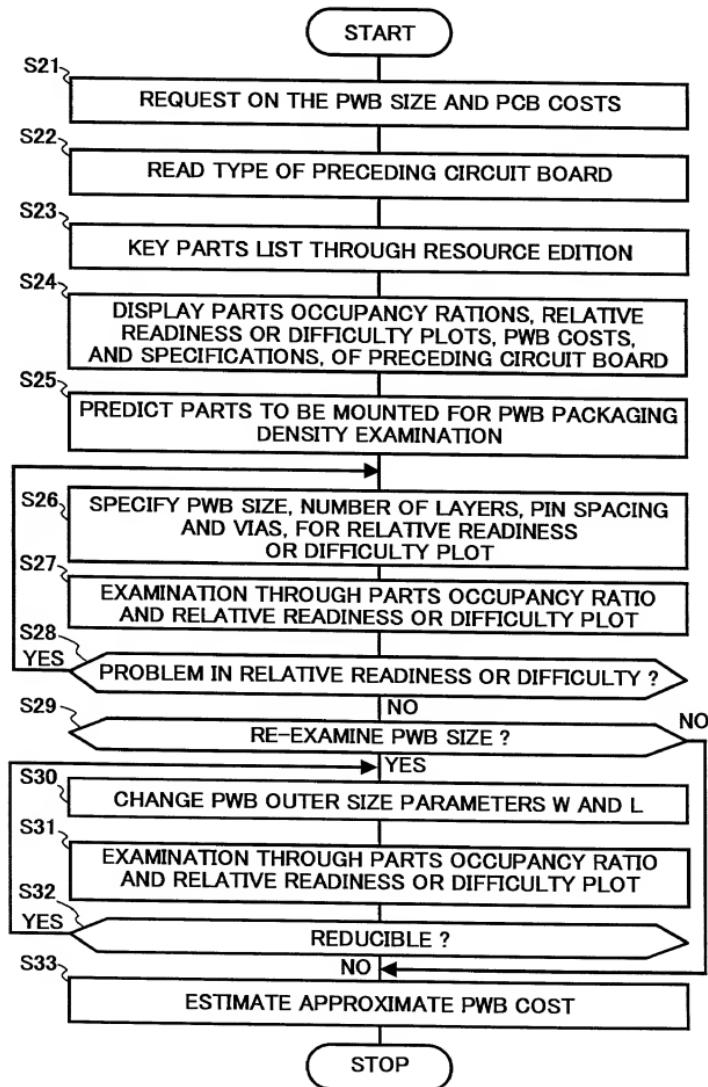
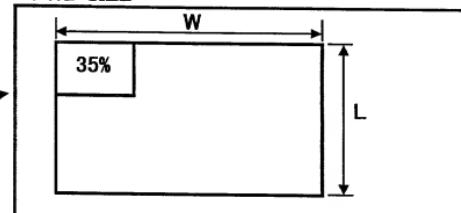


FIG. 12

PACKAGING DENSITY EXAMINATION

**PWB SIZE**



21

W  
35%  
L

**SWITCH PARTS OCCUPANCY RATIO**

22

SINGLE-SIDED    DOUBLE-SIDED MOUNTING

**PWB PARAMETER**

23

W  mm  
L  mm  
PWB AREA  cm<sup>2</sup>  
PIN SPACING   27

**PREDICTION**

24

OBTAINED FROM KEY PARTS  
PIN NUMBER MULTIPLIED  
BY COEFFICIENTS

NUMBER OF PINS   
PARTS OCCUPANCY AREA  cm<sup>2</sup>  
PIN DENSITY  PIN/cm<sup>2</sup>

**KEY PARTS**

25

NUMBER OF PARTS   
NUMBER OF PINS   
PARTS OCCUPANCY AREA  cm<sup>2</sup>

**APPROXIMATE PWB COSTS**

28

**COMMENTS ON PREDICTION COEFFICIENTS**

29

**RESOURCE DISPLAY**

30

FIG.13A

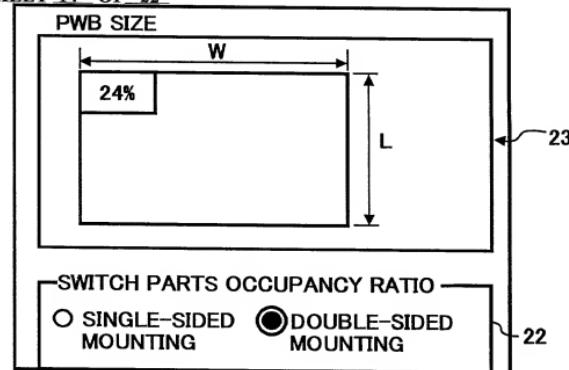


FIG.13B

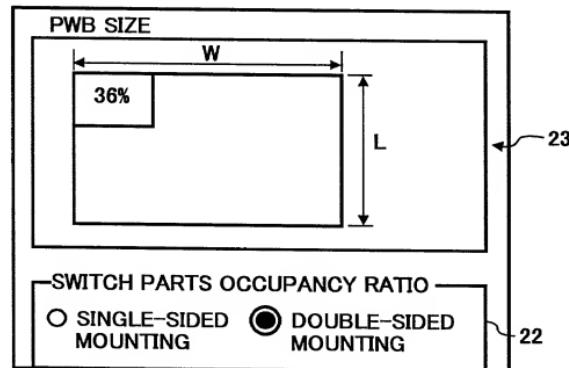


FIG.13C

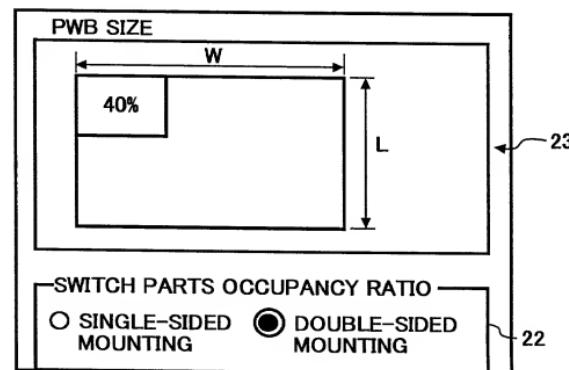


FIG. 14

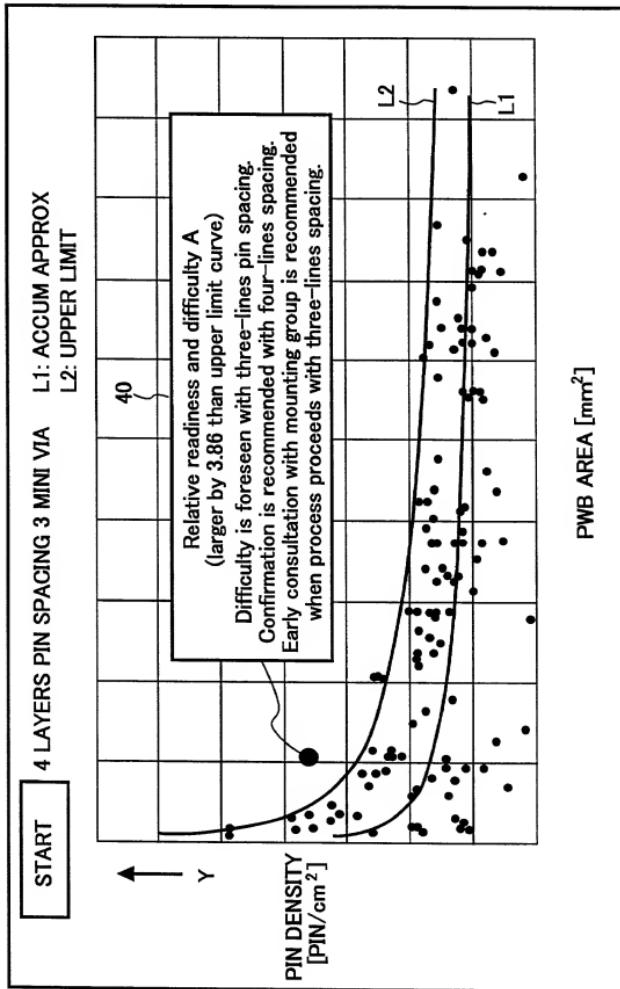


FIG. 15

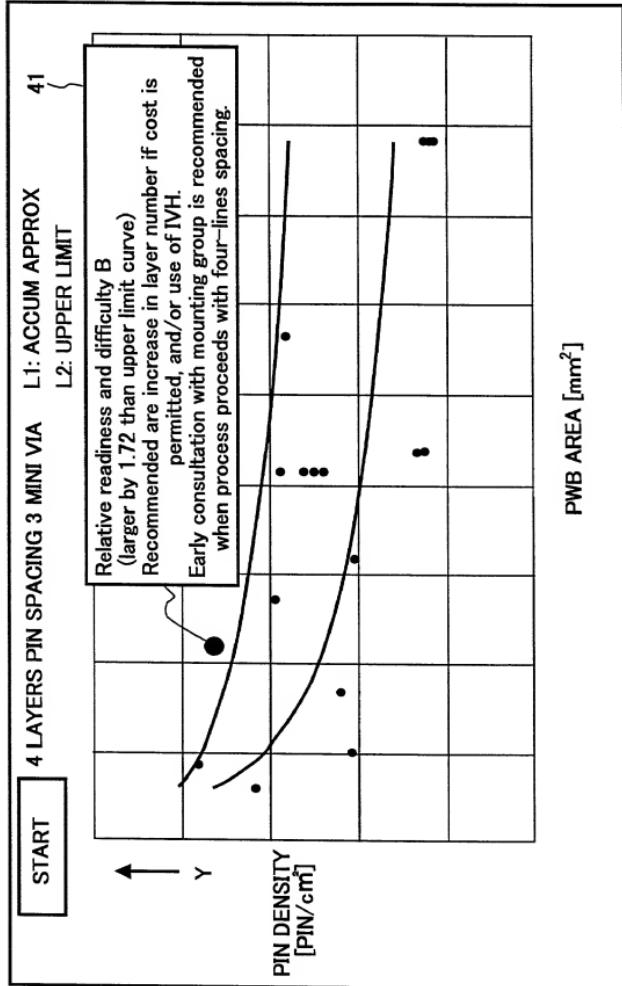


FIG. 16

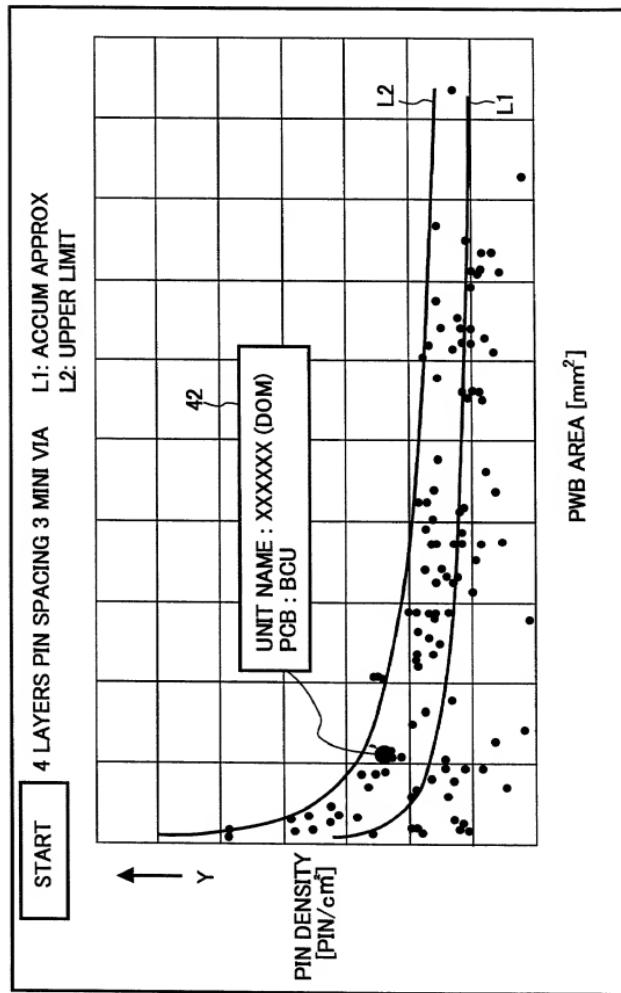


FIG. 17

889 APPROXIMATE COSTS			<input checked="" type="checkbox"/>
PWB SIZE	121 x 90		
PIN SPACING	3 LINES		
SHEET THICKNESS			
<input type="radio"/> 0.8	<input type="radio"/> 1.0	<input type="radio"/> 1.2	<input checked="" type="radio"/> 1.6
MATERIALS			
<input checked="" type="radio"/> FR-4	<input type="radio"/> CFM-3		
VIA			
<input type="radio"/> Middle	<input checked="" type="radio"/> Mini	<input type="radio"/> BVH	
NUMBER OF LAYERS			
<input type="radio"/> 2	<input checked="" type="radio"/> 4	<input type="radio"/> 6	
CUT-OUT SHEET NUMBER = 36			
APPROXIMATE COSTS = 889 YEN			

FIG. 18

X

PARTS PREDICTION COEFFICIENTS

Number of pins and parts occupancy area are estimated based on key parts arrangement. Accordingly, further calculations based on these values may yield results different from those obtained experimental data.

In the present calculation, therefore, prediction coefficients are used as shown below in the table, which are provided to estimate these values more precisely to realize actual mounting on the PWB by taking into account of predicted number of the parts expected to be mounted.

	RATIO OF PIN NUMBER TO TOTAL KEY PARTS PIN NUMBER	AREA PER PIN	PREDICTED PIN NUMBER	PREDICTED AREA (cm <sup>2</sup> )
RESISTOR	1.7	0.8	639	5.11
CAPACITOR	5.2	3.7	209	7.73
OTHER	23.6	7.7	46	3.54

PUSH TO ALTER

ALTER

END

FIG. 19A

INPUT RESOURCE PART NO.

PWB PART NUMBER

43

FIG. 19B

APPROXIMATE PWB COSTS

COMMENTS ON PREDICTION COEFFICIENTS

30

FIG. 19C

APPROXIMATE PWB COSTS

COMMENTS ON PREDICTION COEFFICIENTS

44

FIG. 20

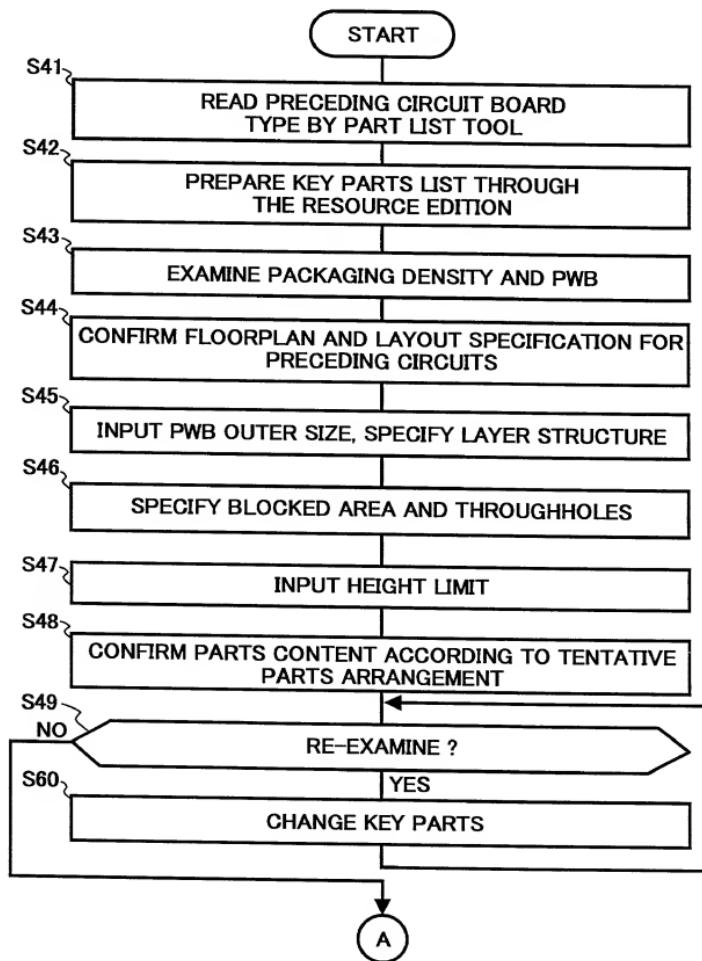


FIG. 21

